

2A, 600V - 1000V Standard Bridge Rectifier

FEATURES

- Ideal for printed circuit board
- High case dielectric strength
- High surge current capability
- UL Recognized File # E-326243
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply
- Adapters
- Lighting application

MECHANICAL DATA

• Case: D3K

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 1A whisker test

Mounting torque: 0.80 N·m maximum Polarity: As marked

• Weight: 1.24g (approximately)

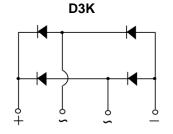
| KEY PARAMETERS | | | | | |
|------------------|------------|------|--|--|--|
| PARAMETER | VALUE | UNIT | | | |
| I _F | 2 | Α | | | |
| V_{RRM} | 600 - 1000 | V | | | |
| I _{FSM} | 62 | Α | | | |
| T_{JMAX} | 150 | °C | | | |
| Package | D3K | | | | |
| Configuration | Quad | | | | |











| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | | |
|--|--|------------------|--------------|---------|------------------|------|
| PARAMETER | | SYMBOL | UR2KB60 | UR2KB80 | UR2KB100 | UNIT |
| Marking code on the device | | | UR2KB60 | UR2KB80 | UR2KB100 | |
| Repetitive peak reve | erse voltage | V_{RRM} | 600 800 1000 | | 1000 | V |
| Reverse voltage, total rms value | | $V_{R(RMS)}$ | 420 | 560 | 700 | V |
| Forward current | Without heat sink, $T_A = 25^{\circ}C$ | | 1.2 | | Α | |
| | With heat sink, T _C = 143°C | - I _F | 2.0 | | | Α |
| Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load | | I _{FSM} | 62 | | А | |
| Rating for fusing (t<8.3ms) | | l ² t | 15.95 | | A ² s | |
| Junction temperature | | TJ | - 55 to +150 | | °C | |
| Storage temperature | | T _{STG} | - 55 to +150 | | | °C |

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| THERMAL PERFORMANCE | | | | | |
|--|------------------|------|------|--|--|
| PARAMETER | SYMBOL | TYP | UNIT | | |
| Junction-to-lead thermal resistance | R _{OJL} | 2.8 | °C/W | | |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 13.4 | °C/W | | |
| Junction-to-case thermal resistance | R _{eJC} | 2.3 | °C/W | | |

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | |
|--|-------------------------------|----------------|-----|------|------|
| PARAMETER | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
| Forward voltage per diode ⁽¹⁾ | $I_F = 1A, T_J = 25^{\circ}C$ | V_{F} | - | 1.05 | V |
| Reverse current @ rated V _R per diode ⁽²⁾ | T _J = 25°C | I _R | - | 10 | μΑ |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | | | | |
|------------------------------|---------|-----------|--|--|--|
| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING | | | |
| UR2KBx | D3K | 25 / Tube | | | |

Notes:

1. "x" defines voltage from 600V(UR2KB60) to 1000V(UR2KB100)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

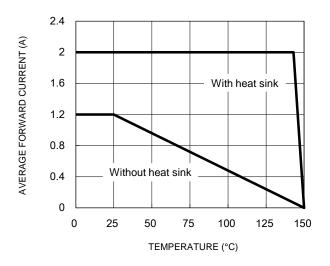


Fig.3 Typical Reverse Characteristics

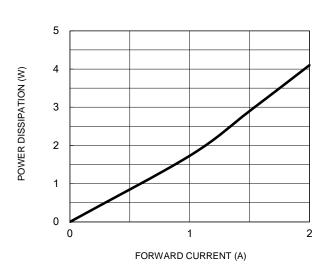
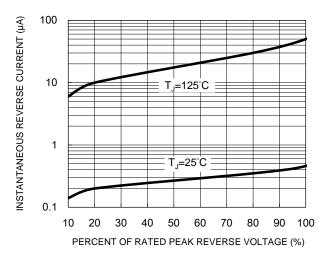


Fig.2 Forward Power Dissipation

Fig.4 Typical Forward Characteristics



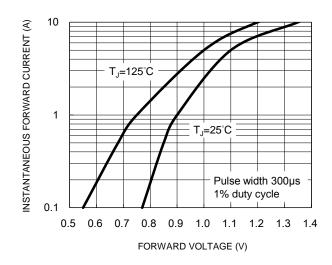
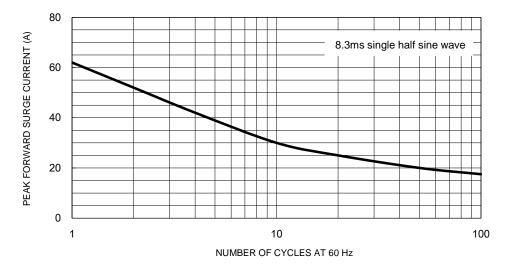


Fig.5 Maximum Non-Repetitive Forward Surge Current



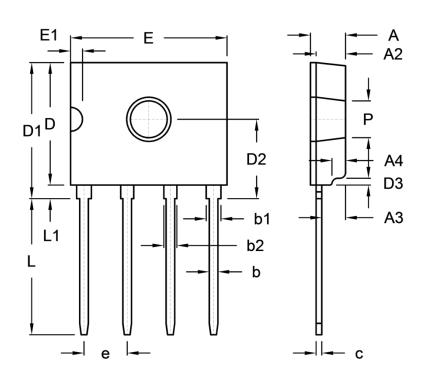
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PACKAGE OUTLINE DIMENSIONS

D3K



| DIM | DIM. Unit (mm) | | Unit (| (inch) |
|------|----------------|-------|--------|--------|
| DIW. | Min. | Max. | Min. | Max. |
| Α | 2.90 | 3.30 | 0.114 | 0.130 |
| A2 | 2.40 | 2.80 | 0.094 | 0.110 |
| A3 | 1.80 | 2.40 | 0.071 | 0.094 |
| A4 | 1.00 | 1.40 | 0.039 | 0.055 |
| b | 0.66 | 0.86 | 0.026 | 0.034 |
| b1 | 1.10 | 1.50 | 0.043 | 0.059 |
| b2 | 1.05 | 1.25 | 0.041 | 0.049 |
| С | 0.40 | 0.60 | 0.016 | 0.024 |
| D | 10.50 | 11.10 | 0.413 | 0.437 |
| D1 | 11.70 | 12.30 | 0.461 | 0.484 |
| D2 | 6.70 | 7.30 | 0.264 | 0.287 |
| D3 | 0.40 | 0.80 | 0.016 | 0.031 |
| E | 13.50 | 14.10 | 0.531 | 0.555 |
| E1 | 0.70 | 1.40 | 0.028 | 0.055 |
| е | 3.51 | 4.11 | 0.138 | 0.162 |
| L | 11.70 | 12.30 | 0.461 | 0.484 |
| L1 | 1.10 | 1.40 | 0.043 | 0.055 |
| Р | 3.10 | 3.40 | 0.122 | 0.134 |

MARKING DIAGRAM



P/N = Marking Code

G = Green Compound

YWW = Date Code F = Factory Code

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